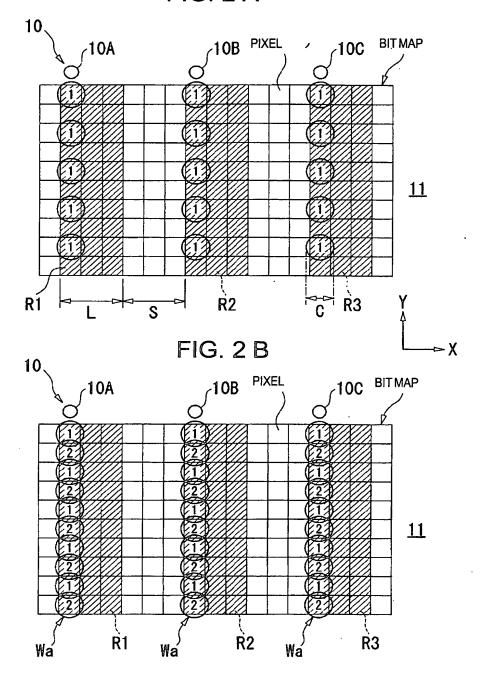
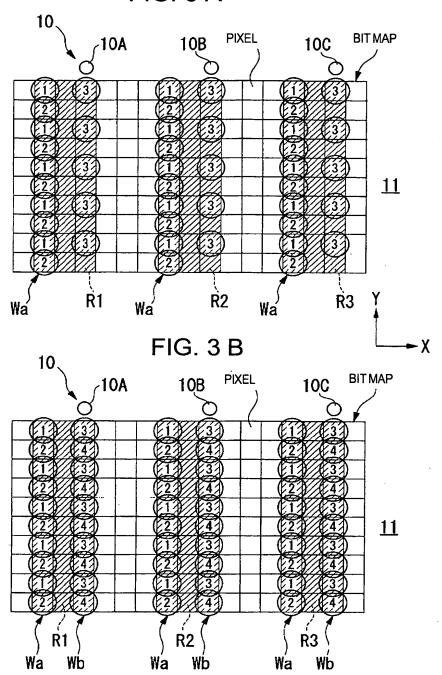


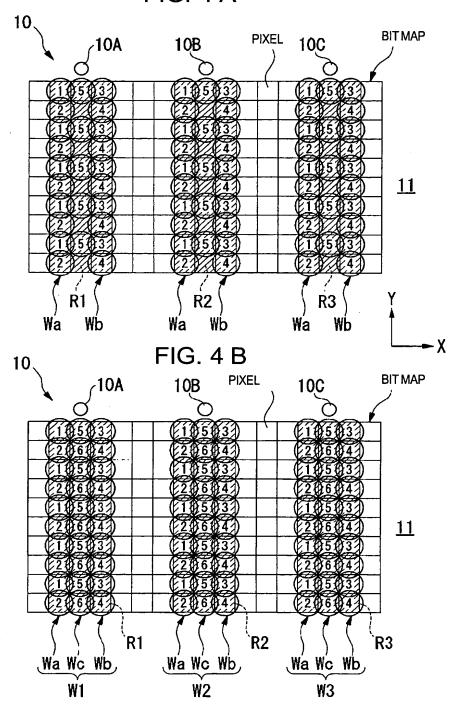
2/17 FIG. 2 A



3/17 FIG. 3 A



4/17 FIG. 4 A



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FIG. 5 A

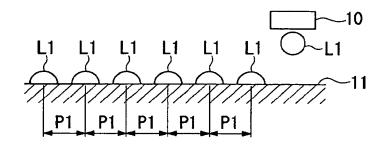


FIG. 5B

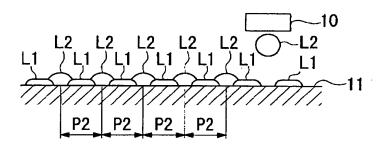
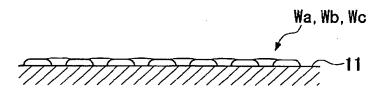
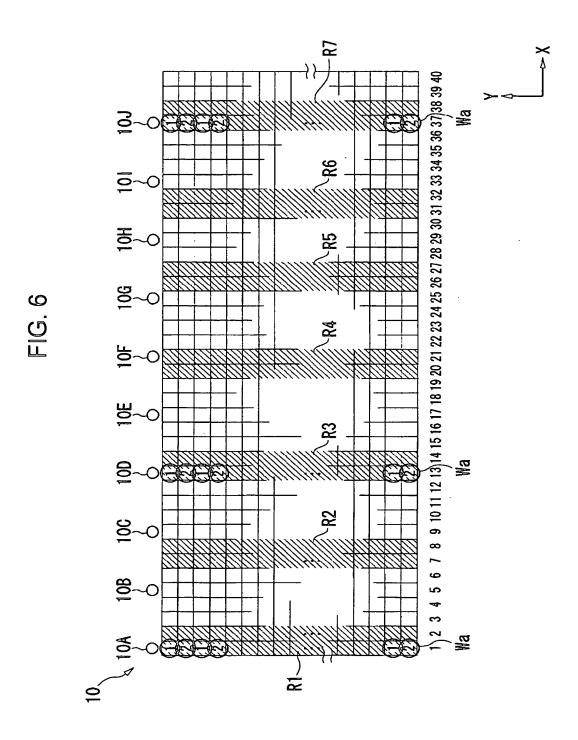


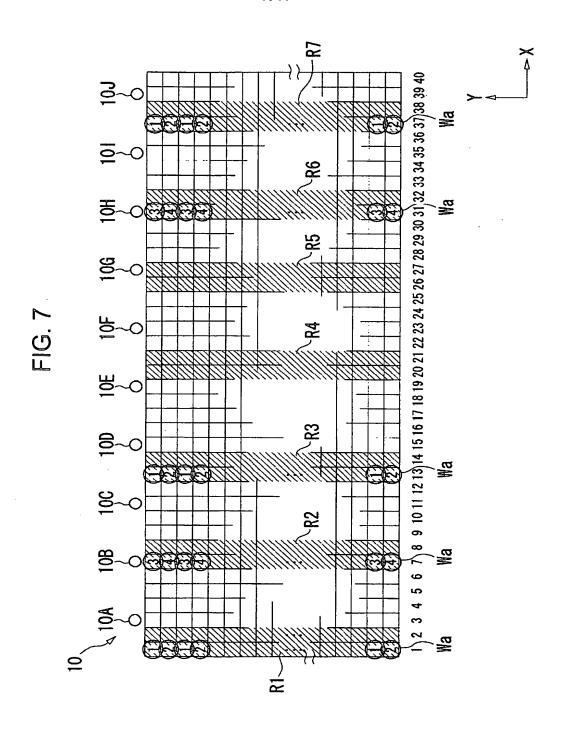
FIG. 5 C



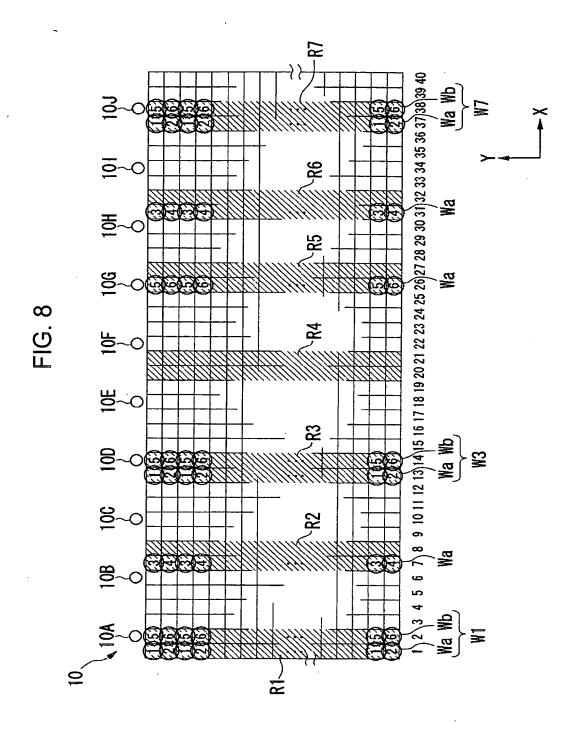
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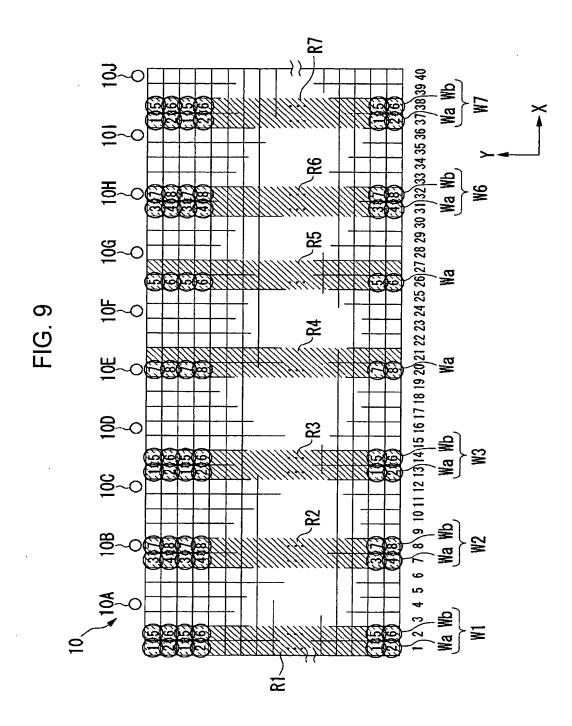
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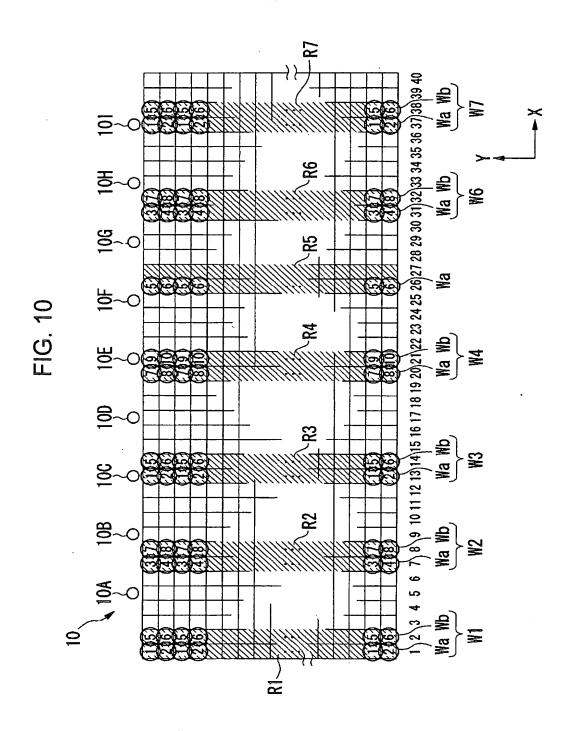
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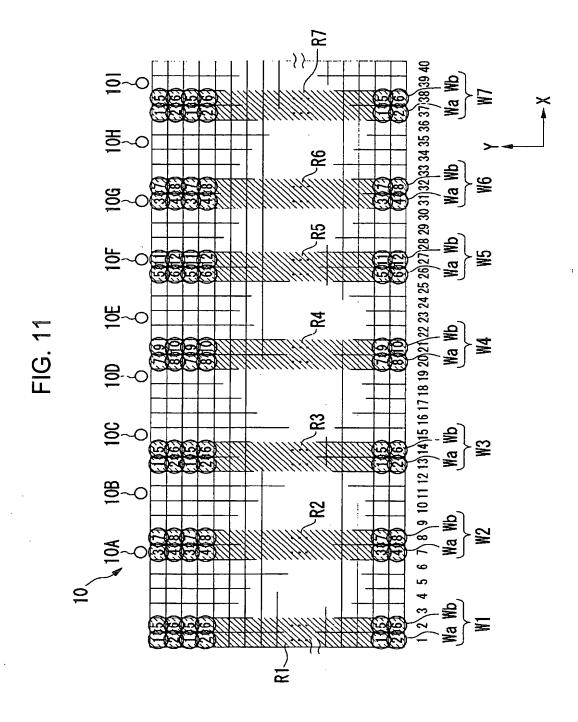
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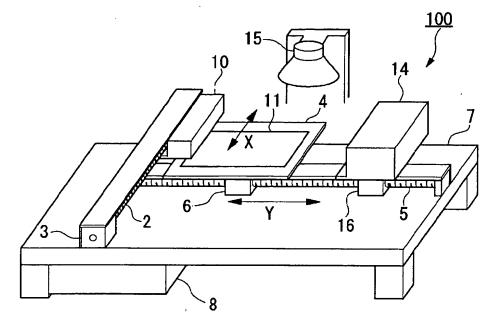
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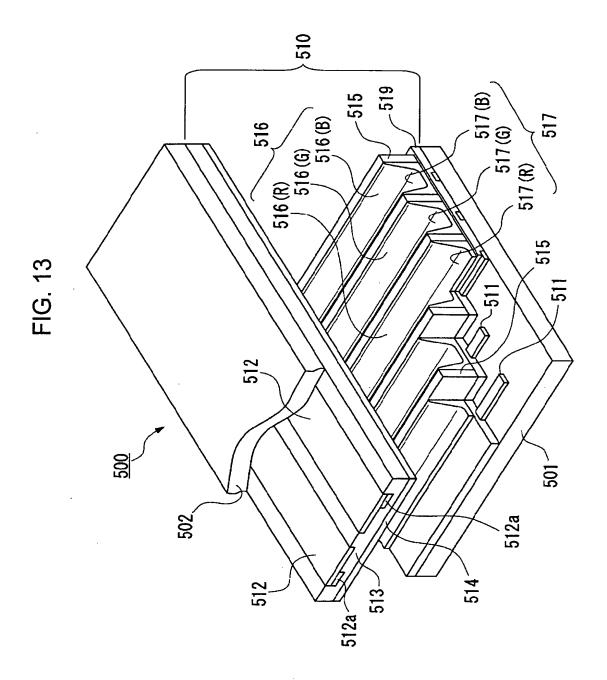


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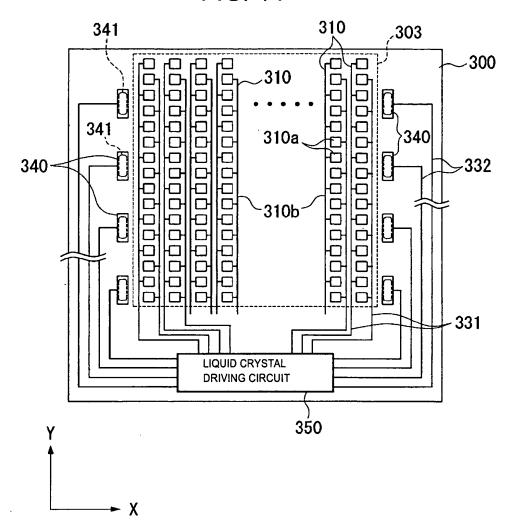


Title: PATTERN FORMING METHOD, PATTERN FORMING APPARATUS, DEVICE MANUFACTURING METHOD, CONDUCTIVE FILM WIRING, ELECTRO-OPTICAL DEVICE, AND ELECTRONIC APPARATUS Inventor: Toshimitsu HIRAI Atty. Ref.: 9319S-000717

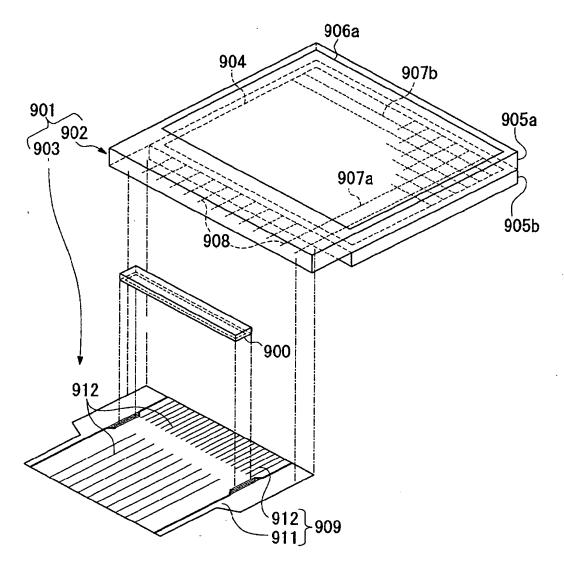
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14/17 FIG. 14

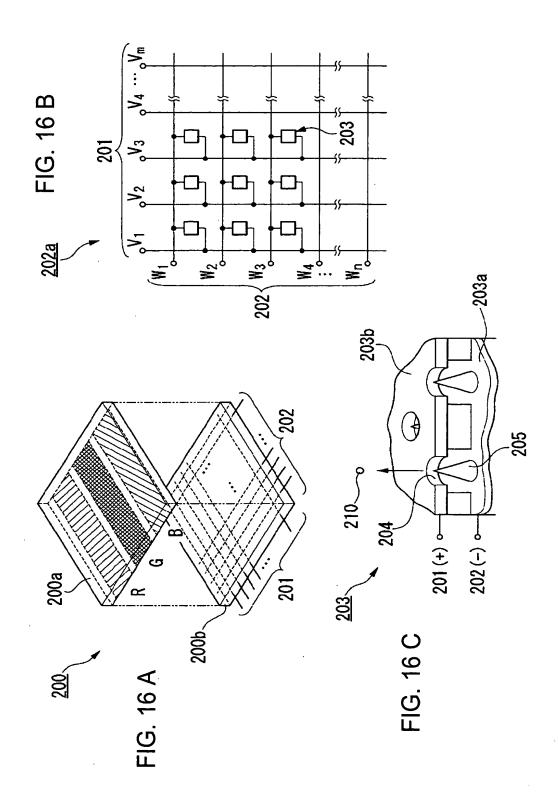


15/17 FIG. 15



Title: PATTERN FORMING METHOD, PATTERN FORMING APPARATUS, DEVICE MANUFACTURING METHOD, CONDUCTIVE FILM WIRING, ELECTRO-OPTICAL DEVICE, AND ELECTRONIC APPARATUS Inventor: Toshimitsu HIRAI Atty. Ref.: 9319S-000717

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17/17 FIG. 17

